

WEICON HB 300



Pasty | steel-filled | high-temperature-resistant up to +280 °C (536 °F) for short periods of time

WEICON HB 300 is pasty, steel-filled and high-temperature-resistant up to +200 °C (392 °F) (up to 280 °C/536 °F for a short period of time). It is processed with a mixing ratio of 1:1. The epoxy resin system is also suitable for applications on vertical surfaces and can be used for the repair and bonding of cast and metal parts, for filling in blow holes, for repairing damage on containers, carriages and machine parts and for sealing pumps and pipes. The product can be used in mechanical and plant engineering, in equipment engineering, and in many other areas of industry.

Characteristics

Base	Epoxy
Filler	steel
Texture	pasty
Colour	dark grey
Minimum shelf life	at room temperature 36 mon.

Processing

Processing temperature	+15°C to +40°C
Component temperature	>3 °C above dew point
Relative air humidity	< 85 %
Mixing ratio by weight	100:100
Mixing ratio by volume	100:90
Viscosity of the mixture	at +25 °C 1.700.000 mPa·s
Density of the mixture	2,5 g/cm ³
Consumption	Layer thickness 1.0 mm 2.5 kg/m ²
Max. layer thickness	per step 20 mm

Curing

Pot life	at 20 °C, 500 g batch	30 min.
Additional layer after	(35 % strength)	6 h
Working strength after	(80 % strength)	10 h
Final strength	(100 % strength)	24 h
Shrinkage		0,15 %

Mechanical properties after curing

- Measured after curing at		24 h RT + 14 h +120 °C
Tensile strength	DIN EN ISO 527-2	50 MPa
Elongation at break (tensile)	DIN EN ISO 527-2	0,7 %
E-modulus (tensile)	DIN EN ISO 527-2	7000-7200 MPa
Compressive strength	DIN EN ISO 604	100 MPa
Bending strength	DIN EN ISO 178	42 MPa
Hardness (Shore D)	DIN ISO 7619	85±3
Adhesive strength	DIN EN ISO 4624	20 MPa
Taber Test	DIN ISO 9352 (H18, 1 kg, 1000 rotations)	1,1 g / 0,4 cm ³
Lap shear strength material thckn. 1,5mm DIN EN 1465		
	Steel 1.0338 sandblasted	14 MPa
	Stainless steel V2A sandblasted	15 MPa
	Aluminium sandblasted	8 N/mm ²
	Galvanized steel	3 MPa

Thermal parameters

Temperature resistance		-35 °C to +200 °C, briefly up to +280 °C
Tg after curing at room temperature	(DSC)	~ +57 °C
Tg after tempering (at 100 °C)		+92
Heat deflection resistance	DIN EN ISO 75-2 (*after tempering)	+100* °C
Thermal conductivity	DIN EN ISO 22007-4	0,5 W/m·K
Heat capacity	DIN EN ISO 22007-4	0,63 J/(g·K)

Electrical parameters

Resistance	DIN EN 62631-3-1	1,5·10 ¹³ Ω·m
Magnetic		yes

Approvals / Guidelines

ISSA Code	75.509.21
IMPA Code	812951

Instructions for use

When using WEICON products, the physical, safety-related, toxicological and ecological data and regulations in our EC safety data sheets (www.weicon.com) must be observed.

Note

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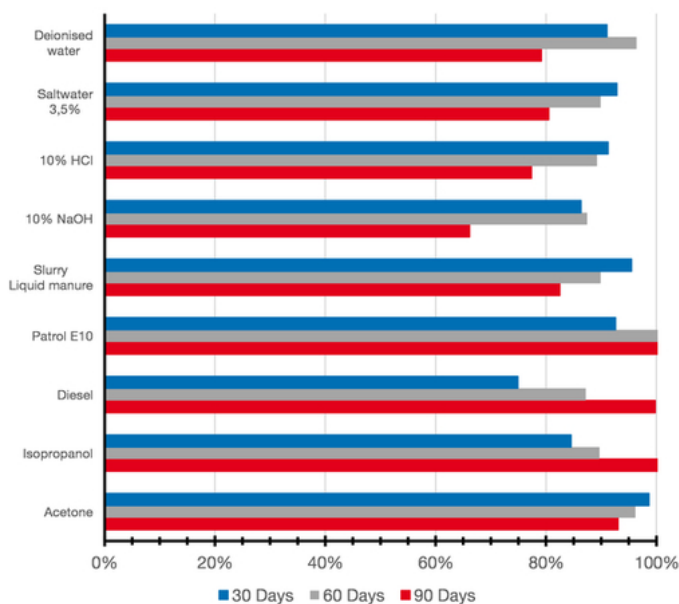
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Surface Pre-Treatment

The successful application of WEICON HB 300 depends on the thorough preparation of the surfaces. This is the most important factor for overall success. Dust, dirt, oil, grease, rust and moisture or wetness have a negative impact on the adhesion. Therefore, before processing WEICON HB 300, the following points must be observed: The areas to be bonded or repaired must be free of any oil, grease, dirt, rust, oxides, paint and other impurities or residues. For cleaning and degreasing, we recommend WEICON Cleaner Spray S.

Smooth and particularly heavily soiled surfaces should additionally be treated by mechanical surface pre-treatment, e.g. by grinding or preferably by blasting. In case of blasting, the surface should be brought to a degree of purity of SA 2 ½ - "Near White Blast Cleaning" (according to ISO 8501/1-2, NACE, SSPC, SIS). In order to achieve an optimum surface roughness of 75 - 100 µm, angular, disposable blasting media (aluminum oxide, corundum) should be used. The surface quality is negatively influenced by the use of reusable blasting media (slag, glass, quartz), but also by ice blasting. The air for blasting must be dry and oil-free. Metal parts that have come into contact with sea water or other salt solutions should first be rinsed thoroughly with demineralised water and, if possible, left to rest overnight so that all salts can be dissolved from the metal. Before each application of WEICON HB 300, a test for soluble salts should be carried out according to the Bresle method (DIN EN ISO 8502-6).

The maximum amount of soluble salts remaining on the substrate should not exceed 40 mg/m². Heating and repeated blasting of the surface may be necessary to remove all soluble salts and moisture.

After each mechanical pre-treatment, the surface should be cleaned again with WEICON Cleaner Spray S and protected from further contamination until the coating is applied.

Areas where no adhesion to the substrate is desired must be treated with silicone-free mould release agents. For smooth surfaces, we recommend WEICON Mould Release Agent Liquid F 1000 or, for porous surfaces, WEICON Mould Release Agent Wax P 500.

After the surface pre-treatment, WEICON HB 300 should be applied as soon as possible (within one hour) to avoid oxidation, flash rust or new contamination.

Mixing

First, stir the resin. Then mix the resin and hardener together thoroughly and bubble-free for at least four minutes at 20 °C (68 °F). The included processing spatula or a mechanical mixer, such as a mortar stirrer, can be used for this purpose. With mechanical mixers, a low speed of max. 500 rpm should be used. The components should be stirred until a homogeneous mixture is achieved. The mixing ratio of the two components must be strictly observed, as otherwise, strongly deviating physical values will result (max. deviation +/- 2 %). Only prepare a batch as large as can be processed within the pot life of 30 minutes. The specified pot life refers to a material batch of 500 g and 20 °C (68 °F) material temperature. Mixing larger quantities or higher processing temperatures will result in faster curing due to the typical reaction heat of epoxy resins.

Application

For processing, we recommend an ambient temperature of 20 °C (68 °F) at less than 85% relative humidity. For a thin pre-coat, work WEICON HB 300 intensively into the surface in crosswise layers using the Contour Spatula Flexy to achieve maximum adhesion. By means of this technique, the epoxy resin penetrates well into all cracks and roughness depths. Afterwards, further applications can be carried out straight away, until the desired layer thickness is reached. Make sure that the epoxy resin is applied evenly and without air bubbles. To fill large gaps or holes, fibreglass, expanded metal or other mechanical fixing materials should be used. Finally, the surface can be smoothed easily with the help of a PE film and a rubber roller.

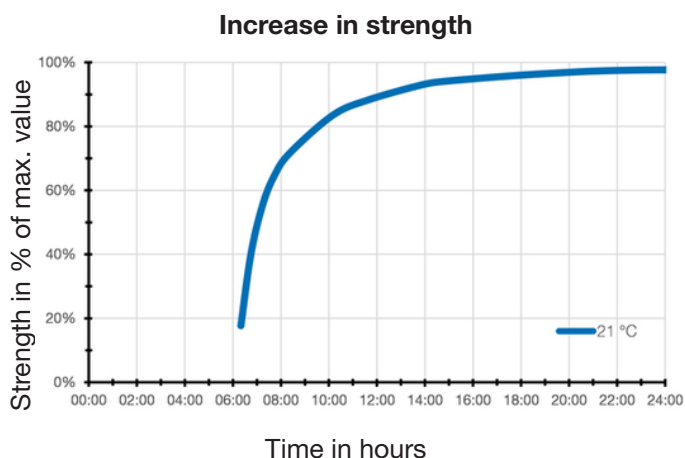
Curing

Final hardness is reached after 24 hours at 20 °C (68 °F) at the latest. At lower temperatures, the curing can be accelerated by evenly applying heat up to max. 40 °C (104 °F), e.g. with a heating pack, hot air blower or fan heater. Higher temperatures shorten the curing time. The following rule of thumb applies: Each increase by +10 °C (50 °F) above room temperature (20 °C/68 °F) will decrease the curing time by half. Temperatures below 16 °C (61 °F) increase the curing time,

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until at approx. 5 °C (41 °F) and below, almost no reaction will take place at all.



Storage

WEICON Epoxy Resin Systems should be stored in a dry place at room temperature. Unopened containers can be stored at temperatures from +18 °C to +28 °C. Opened containers must be used up within 6 months.

Scope of delivery

Processing Spatula | Contour Spatula Flexy | Instructions for use | Gloves | Resin & Hardener

Accessories

- 10045523 Processing Kit, 1 PCE
- 10000147 Cleaner Spray S, 500 ml, transparent
- 10000347 Cleaner S, 5 L, colourless, transparent
- 10024313 Surface Cleaner, 400 ml, transparent
- 10025288 Surface Cleaner, 5 L, transparent
- 10026647 Mould Release Agent Liquid F 1000, 250 ml, white, milky
- 10026712 Mould Release Agent Wax P 500, 150 g
- 10053995 Repair Stick Multi-Purpose, 115 g, vintage white
- 10000913 Glass Fibre Cloth Tape, 1 PCE, white
- 10010887 Processing Spatula short, 1 PCE
- 10022562 Processing Spatula long, 1 PCE
- 10039667 Cable Scissors No. 35, 1 PCE
- 10016002 Pump Dispenser WPS 1500, 1 PCE

Recommended equipment

- Angle grinder
- Blast machine
- Heat pocket
- Hot or fan heater
- Smoothing trowel, spatula
- PE film 0.2 mm
- Fabric tape
- Brush
- Foam roller
- Rubber roller
- Lint-free cloth

Conversion table

- (°C x 1.8) + 32 = °F
- mm/25.4 = inch
- µm/25.4 = mil
- N x 0.225 = lb
- N/mm² x 145 = psi
- MPa x 145 = psi
- Nm x 8.851 = lb·in
- Nm x 0.738 = lb·ft
- Nm x 141.62 = oz·in
- mPa·s = cP
- N/cm x 0.571 = lb/in
- kV/mm x 25.4 = V/mil

Available sizes

- 10000099 WEICON HB 300, 1 kg, dark grey
- 10001084 WEICON HB 300, 0,5 kg, dark grey
- 10004472 WEICON HB 300, 200 g, dark grey

	WEICON A	WEICON B	WEICON BR	WEICON C	WEICON F	WEICON F2	WEICON HB 300	WEICON HT 111	WEICON SF	WEICON ST	WEICON TT	WEICON UW	WEICON WR2	WEICON HP	WEICON Fire Safe	WEICON Anti-Static	WEICON Food Grade	WEICON Anti-Static	WEICON Ceramic BL	WEICON GL	WEICON GL-S	WEICON Ceramic W	WEICON Ceramic HC 220	WEICON WP	WEICON WR	WEICON CBC
Repair and moulding	x	x	x	x	x	x	x	x	x	x	x	x	x													
Adhesive				x	x		x	x		x				x	x											
Wear, erosion and corrosion protection – abrasion-resistant coating																	x	x	x	x	x	x	x	x		
Casting, relining and gap compensation – casting and injecting potting compound	x					x							x												x	x

To the product detail page:



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Chemical resistance after curing* (Excerpt)

1,4-Dioxane	-	Glycol	+
Exhaust fumes	+	Uric acid	-
Adipic acid	-	Impregnating oils	+
aliphatic hydrocarbons	+	Iodides (K, Na etc.)	-
Formic acid >10 % (methanoic acid)	-	Potassium carbonate	+
Ammonia anhydrous 25%	-	Potassium hydroxide 0-20 % (caustic potash)	+
Aniline	-	Milk of lime	+
aromatic hydrocarbons	+	Cresol	-
Barium hydroxide	+	Magnesium hydroxide	+
Benzoic acid	-	Maleic acid (cis-ethylenedicarboxylic acid)	-
Benzyl alcohol	-	Methanol (methyl alcohol) <85 %	o
Benzyl chloride	-	Methylene chloride	-
Boric acid	-	Mineral oil	+
Bromides	-	Naphthalene	+
Butadiene (1,3-)	-	Sodium bicarbonate (sodium hydrogen carbonate)	+
Butyric acid	-	Sodium carbonate (soda)	+
Butyl acetate	o	Sodium chloride (table salt)	+
Butyl alcohol	o	Nitrates	-
Calcium hydroxide (slaked lime)	+	Nitrobenzene	-
Chloroanilines	-	Oils, vegetable and animal	+
Chloroform (trichlormethane)	-	Oxalic acid <25 % (ethanedioic acid)	o
Chlorosulphuric acid (wet and dry)	-	Perchloroethylene	-
Chlorosilanes	-	Kerosene	+
Chlorinated water (swimming pool concentration)	-	Phenol	-
Chromates (K, Na, etc.)	-	Phosphoric acid <50%	+
Chromic acid	-	Phthalic acid, phthalic anhydride	-
Cyanides (K, Na etc.)	-	Nitric acid <5%	-
Cyclohexanone	-	Sulphur dioxide (wet and dry)	-
Diethyl ether	+	Carbon disulphide	-
Mineral oil and mineral oil products	+	Sulphuric acid <5%	+
Acetic acid diluted <5%	o	Soap solution	+
Ethanol <85 % (ethyl alcohol)	o	Turpentine	+
Greases, oils and waxes	+	Carbon tetrachloride (tetrachloromethane)	-
Hydrofluoric acid	-	Tetralin (tetrahydronaphthalene)	-
Tannic acid diluted <7%	o	Trichloroethylene	-
Glycerin (trihydroxipropane)	+	Hydrogen peroxide <30 % (hydrogen superoxide)	o

+ = resistant 0 = for a limited time - = not resistant *The storage of all WEICON Plastic Metal types was carried out at +20°C chemical temperature.

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